Document Number: MC146010

Rev. 1.0, 5/2007

# Low Power CMOS Photoelectric Smoke Detector IC

The MC146010 is an advanced smoke detector component containing sophisticated very-low power analog and digital circuitry. The IC, when used with an infrared photoelectric chamber and a small number of external components, will detect smoke by sensing scattered light from smoke particles. When detection occurs, a pulsating alarm is sounded via on-chip push-pull drivers and an external piezoelectric transducer.

The MC146010 provides both audible and visual alarms. Upon sensing a normal smoke level, both alarms will be activated. It is possible to mute the audible alarm for approximately eight minutes through the Integrated Mute Function (IMF), although the LED will continue to flash at a high rate. This feature is resettable through a pushbutton test. The IMF feature will be overridden by remote smoke, high smoke level, timeout or reset.

The Alarm memory feature will allow for identification of an alarming detector. Through a pushbutton test, the LED will flash rapidly if there was a previous alarm condition detected at the unit.

The variable-gain photo amplifier allows direct interface to IR detector (photodiode). The gain settings are determined by external capacitors and compensation resistors. A two stage speed-up is incorporated into the smoke monitor to minimize time and help reduce false triggering. Further reduction of false triggering is also addressed with the double sample chamber sensitivity and double I/O sample.

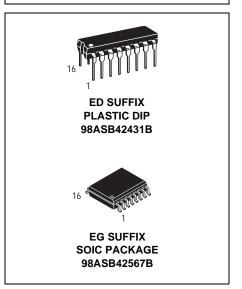
#### **Features**

- Integrated Mute Function (IMF) to Temporarily Disable Horn
- Alarm Memory to Help Identify Alarming Unit
- Speed-Up Sampling Rate After First Detection of Smoke
- Double Sample for Degraded Chamber Sensitivity Monitor
- Digital Noise Filter on the I/O Pin
- Power-Up and Power-Down RESET
- Low-Battery Trip Point Set Externally
- Temporal Horn Pattern
- Operating Temperature: -10 to 75°C
   Operating Voltage Range: 6.0 to 12 V
   Average Supply Current: 6.5 μA

|                            | ORDERING INFORMATION |              |  |  |  |  |  |
|----------------------------|----------------------|--------------|--|--|--|--|--|
| Device Temp. Range Package |                      |              |  |  |  |  |  |
| MC146010ED                 | -10 to 75°C          | Plastic Dip  |  |  |  |  |  |
| MCZ146010EG/R2             | -10 to 75 C          | SOIC Package |  |  |  |  |  |

# MC146010

LOW POWER CMOS
PHOTOELECTRIC SMOKE
DETECTOR IC





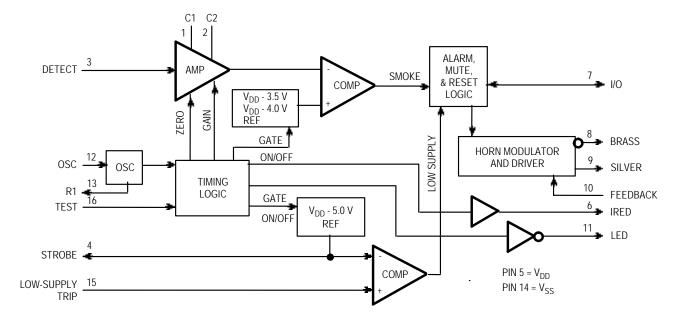


Figure 1. Block Diagram

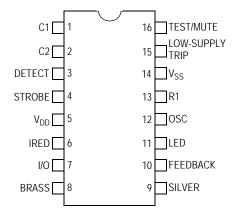


Figure 2. Pin Assignment (16-Pin DIP)

Table 1. Maximum Ratings<sup>(1)</sup> (Voltages Referenced to V<sub>SS</sub>)

| Symbol           | Parameter   |   | Value   | Unit |
|------------------|---|---|---|------|
| $V_{DD}$         | DC Supply Voltage   |   | -0.5 to +12   | V    |
| V <sub>IN</sub>  | DC Input Voltage  | C1, C2, Detect<br>Osc, Low-Supply Trip<br>I/O<br>Feedback<br>Test | -0.25 to V <sub>DD</sub> +0.25<br>-0.25 to V <sub>DD</sub> +0.25<br>-0.25 to V <sub>DD</sub> +10<br>-15 to +25<br>-1.0 to V <sub>DD</sub> +0.25 | V    |
| I <sub>IN</sub>  | DC Input Current, per Pin   |   | ±10   | mA   |
| I <sub>OUT</sub> | DC Output Current, per Pin  |   | ±25   | mA   |
| I <sub>DD</sub>  | DC Supply Current, V <sub>DD</sub> /V <sub>SS</sub> pins (15 Seconds in Reverse Dir.) |   | +25 Forward<br>-150 Reverse   | mA   |
| $P_{D}$          | Power Dissipation   | † in Stil Air, 5 sec.<br>†† Continuous                            | 1200 <sup>(2)</sup><br>350 <sup>(3)</sup>   | mW   |
| T <sub>stg</sub> | Storage Temperature   |   | -55 to +125   | °C   |
| T <sub>A</sub>   | Operating Temperature   |   | -25 to +75  | °C   |
| T <sub>L</sub>   | Lead Temperature, 1 mm from case for 10 seconds                                       |   | 260   | °C   |

<sup>1.</sup> Maximum ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the limits in the electrical characteristics tables.

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of voltages any higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{\text{IN}}$  and  $V_{\text{OUT}}$  should be constrained to a range of  $V_{\text{SS}} \leq (V_{\text{IN}})$  or

 $V_{OUT}) \le V_{DD}$  except for I/O pin which can exceed  $V_{DD}$ , and the Test/Mute input, which can go below  $V_{SS}$ .

Unused inputs must always be tied to an appropriate logic voltage level (e.g. either  $V_{SS}$  or  $V_{DD}$ ). Unused outputs and/or an unused I/O must be left open.

Table 2. Electrical Characteristics (Voltages Referenced to V<sub>SS</sub>, T<sub>A</sub> = -10 to 60°C unless otherwise indicated.)

| Symbol          | Parameter   | Test Condition   | Test<br>Pin            | V <sub>DD</sub>      | Min                          | Max                          | Unit |
|-----------------|---|--|------------------------|----------------------|------------------------------|------------------------------|------|
| V <sub>DD</sub> | Power Supply Voltage Range  |  | _                      | _                    | 6.0                          | 12                           | V    |
| V <sub>TH</sub> | Supply Threshold Voltage, Low Supply Alarm  | Low Supply Trip: $V_{IN} = V_{DD}/3$   | 15                     | _                    | 7.2                          | 7.8                          | V    |
| I <sub>DD</sub> | Average Operating Supply Current (per Package) (Does not include Current through D3-IR Emitter) | Standby<br>Configured per Figure 5   | _<br>_                 | 12<br>9.0            | _<br>_                       | 9.0<br>7.0                   | μА   |
| I <sub>DD</sub> | Peak Supply Current (per Package)<br>(Does not include IRED Current into base of Q1)            | During Strobe On, IRED Off<br>Configured per Figure 5<br>During Strobe On, IRED On<br>Configured per Figure 5  |                        | 12<br>12             | _                            | 1.25<br>2.5                  | mA   |
| V <sub>IL</sub> | Low Level Input Voltage I/O Feedback Test   |  | 7.0<br>10<br>16        | 9.0<br>9.0<br>9.0    |                              | 1.5<br>2.7<br>0.5            | V    |
| V <sub>IM</sub> | Mid Level Input Voltage Test  |  | 16                     | 9.0                  | 2.0                          | V <sub>DD</sub> -2.0         | V    |
| V <sub>IH</sub> | High Level Input Voltage I/O Feedback Test  |  | 7.0<br>10<br>16        | 9.0<br>9.0<br>9.0    | 3.2<br>6.3<br>8.5            | <br>_<br>_                   | V    |
| I <sub>IN</sub> | Input Current OSC, Detect Low-Supply Trip Feedback Test   | $\begin{aligned} & V_{\text{IN}} = V_{\text{SS}} \text{ or } V_{\text{DD}} \\ & V_{\text{IN}} = V_{\text{SS}} \text{ or } V_{\text{DD}} \\ & V_{\text{IN}} = V_{\text{SS}} \text{ or } V_{\text{DD}} \\ & V_{\text{IN}} = V_{\text{SS}} \text{ or } V_{\text{DD}} \end{aligned}$ | 3.12<br>15<br>10<br>16 | 12<br>12<br>12<br>12 | -100<br>-100<br>-100<br>-100 | +100<br>+100<br>+100<br>+100 | nA   |
| I <sub>IL</sub> | Test Mode Input Current   | $V_{IN} = V_{SS}$ or $V_{DD}$  | 16                     | 12                   | -100                         | -1.0                         | μΑ   |

<sup>2.</sup> Derating: -12 mW/°C from 25°C to 60°C.

<sup>3.</sup> Derating: -3.5 mW/°C from 25°C to 60°C.

 $\textbf{Table 2. Electrical Characteristics} \ (Voltages \ Referenced \ to \ V_{SS}, \ T_A = -10 \ to \ 60^{\circ}C \ unless \ otherwise \ indicated.) \ (continued)$ 

| Symbol              | Parameter   | Test Condition  | Test<br>Pin | V <sub>DD</sub>        | Min  | Max                       | Unit     |
|---------------------|---|---|-------------|------------------------|--|---------------------------|----------|
| I <sub>IH</sub>     | Pull-Down Current Test I/O  | $V_{IN} = V_{DD}$ $I/O V_{IN} = V_{DD}$ $I/O V_{IN} = 17 V$   | 16<br>7.0   | 12<br>9.0<br>9.0<br>12 | <br>0.5<br>25<br>                            | -1.0<br>1.0<br>100<br>140 | μA<br>μA |
| V <sub>OL</sub>     | Low-Level Output Voltage LED Silver, Brass                        | I <sub>OUT</sub> = 10 mA<br>I <sub>OUT</sub> = 16 mA  | 11<br>8.9   | 6.5<br>6.5             | _  | 0.6<br>1.0                | V        |
| V <sub>OH</sub>     | High-Level Output Voltage Silver, Brass                           | I <sub>OUT</sub> = -16 mA   | 8.9         | 6.5                    | 5.5  | _                         | V        |
| V <sub>OUT</sub>    | Output Voltage Strobe (For Line Regulation, See Pin Descriptions) | Inactive, I <sub>OUT</sub> = 1.0 μA<br>Active, I <sub>OUT</sub> = 100 to 500 μA<br>(Load Regulation)                | 4.0<br>9.0  | 9.0                    | V <sub>DD</sub> -0.1<br>V <sub>DD</sub> -5.4 | —<br>V <sub>DD</sub> -4.6 | V        |
| I <sub>OH</sub>     | High-Level Output Current I/O                                     | Local Smoke, V <sub>OUT</sub> = 4.5 V<br>Local Smoke, V <sub>OUT</sub> = V <sub>SS</sub><br>(Short Circuit Current) | 7.0<br>—    | 6.5<br>12              | -4.0<br>—                                    | <u> </u>                  | mA       |
| I <sub>OZ</sub>     | Off-State Output Leakage Current LED                              | $V_{OUT} = V_{SS}$ or $V_{DD}$  | 11          | 12                     | _  | ±100                      | nA       |
| V <sub>OL</sub>     | Active  | 1.0 mA  | _           | 6.5                    | _  | 0.5                       | V        |
| V <sub>IC</sub>     | Common Mode C1, C2, Detect Voltage Range                          | Local Smoke, Pushbutton, or<br>Chamber Sensitivity Test   | _           | _                      | V <sub>DD</sub> -4.0                         | V <sub>DD</sub> -2.0      | V        |
| V <sub>REF</sub>    | Smoke Comparator Internal Reference Voltage                       | Local Smoke, Pushbutton, or<br>Chamber Sensitivity Test   | _           | _                      | V <sub>DD</sub> -3.9                         | V <sub>DD</sub> -3.1      | V        |
| V <sub>REF-HI</sub> | High Smoke Comparator Internal Reference Voltage                  | Local Smoke, Pushbutton, or<br>Chamber Sensitivity Test   | _           | 1                      | V <sub>REF</sub> -<br>0.52                   | V <sub>REF</sub> -0.48    | V        |

<sup>\*</sup> T<sub>A</sub> = 25°C Only

**Table 3. AC Electrical Characteristics** (Refer to Timing Diagram Figure 3 and Figure 4.  $T_A = 25$  °C,  $V_{DD} = 9.0$  V, Component Values from Figure 5.)

| No. | Symbol                            | Parameter   | Test Condition                                   | Clocks           | Min <sup>(1)</sup> | Typ <sup>(2)</sup> | Max <sup>(1)</sup> | Unit |
|-----|-----------------------------------|---|--|------------------|--------------------|--------------------|--------------------|------|
| 1   | 1/f <sub>OSC</sub>                | Oscillator period   | Free-running Saw tooth<br>Measured at Pin 12     | 1.0              | 9.5                | 10.5               | 11.5               | ms   |
| 2   | t <sub>LED</sub>                  | LED Pulse Period  | No Local Smoke, and No<br>Remote Smoke           | 4096             | 38.9               | 43                 | 47.1               | S    |
| 3   |                                   |   | Remote Smoke, but No Local Smoke                 | _                |                    |                    | _                  |      |
| 4   |                                   |   | Local Smoke                                      | 64               | 0.6                | 0.67               | 0.74               |      |
| 5   |                                   |   | Pushbutton Test                                  | 64               | 0.6                | 0.67               | 0.74               |      |
| ?   |                                   |   | Pushbutton Test with<br>Alarm Memory             | 4.0              | 38                 | 42                 | 46                 | ms   |
| 6   | $t_{w(LED)}, \ t_{w(stb)}$        | LED Pulse Width and Strobe Pulse Width                      | Remote Smoke but No Local Smoke                  | 1.0              | 9.5                | 10.5               | 11.5               | ms   |
| 7   | t <sub>IRED</sub>                 | IRED Pulse Period   | Smoke Test                                       | 1024             | 9.67               | 10.8               | 11.83              | s    |
| 8   |                                   |   | Chamber Sensitivity Test,<br>Without Local Smoke | 4096             | 38.9               | 43                 | 47.1               |      |
| 9   |                                   |   | Local Smoke, in Speed-Up                         | 128              | 1.2                | 1.3                | 1.5                |      |
|     |                                   |   | Pushbutton Test                                  | 128              | 1.2                | 1.3                | 1.5                |      |
| 10  | t <sub>w(IRED)</sub>              | IRED Pulse Width  |  | T <sub>f</sub> * | 94                 | _                  | 116                | μS   |
| 11  | t <sub>MOD</sub>                  | Silver and Brass Modulation Period<br>Local or Remote Smoke |  | 32               | 304                | 336                | 368                | ms   |
| 12  | t <sub>ON</sub> /t <sub>MOD</sub> | Silver and Brass Duty Cycle Local or<br>Remote Smoke        |  | _                | 73                 | 75                 | 77                 | %    |

**Table 3. AC Electrical Characteristics** (Refer to Timing Diagram Figure 3 and Figure 4.  $T_A = 25$ °C,  $V_{DD} = 9.0$  V, Component Values from Figure 5.) (continued)

| No. | Symbol             | Parameter                                      | Test Condition                                  | Clocks | Min <sup>(1)</sup> | Typ <sup>(2)</sup>   | Max <sup>(1)</sup> | Unit |
|-----|--------------------|--|---|--------|--------------------|----------------------|--------------------|------|
| 13  | t <sub>CH</sub>    | Silver and Brass Chirp Pulse Period            | Low Supply or Degraded<br>Chamber Sensitivity   | 4096   | 38.9               | 43                   | 47.1               | S    |
| 14  | t <sub>W(CH)</sub> | Silver and Brass Chirp Pulse Width             | Low Supply or Degraded<br>Chamber Sensitivity   | 1.0    | 9.5                | 10.5                 | 11.5               | ms   |
| 15  | t <sub>RR</sub>    | Rising Edge on IO to Smoke Alarm Response Time | Remote Smoke, No local smoke                    | _      | _                  | 2 sec <sup>(3)</sup> | _                  |      |
| 16  | t <sub>stb</sub>   | Strobe Out Pulse Period                        | Smoke Test                                      | 1024   | 9.67               | 10.8                 | 11.83              | s    |
| 17  |                    |  | Chamber Sensitivity Test<br>Without Local Smoke | 4096   | 38.9               | 43                   | 47.1               | S    |
| 18  |                    |  | Low Supply Test Without Local<br>Smoke          | 4096   | 38.9               | 43                   | 47.1               | s    |
| 19  |                    |  | Pushbutton Test/Speed-Up                        | 128    | 1.2                | 1.3                  | 1.5                | s    |
| 20  | t <sub>MUTE</sub>  | Mute time                                      | Local smoke                                     | _      | 7.0                | 10                   | 14                 | min  |

<sup>1.</sup> Oscillator period T ( $T = T_r + T_f$ ) is determined by the external components  $R_1$ ,  $R_2$  and  $C_3$  where  $T_r = (0.6931)R_2*C_3$  and  $T_f = (0.6931)R_1*C_3$ . The other timing characteristics are some multiple of the oscillator timing shown in the table. The timing shown should accommodate the NFPA72, ANSI S3.41, and ISO8201 audible emergency evacuation signals.

<sup>2.</sup> Typicals are not guaranteed.

<sup>3.</sup> Time is typical-depends on what point in cycle the signal is applied.

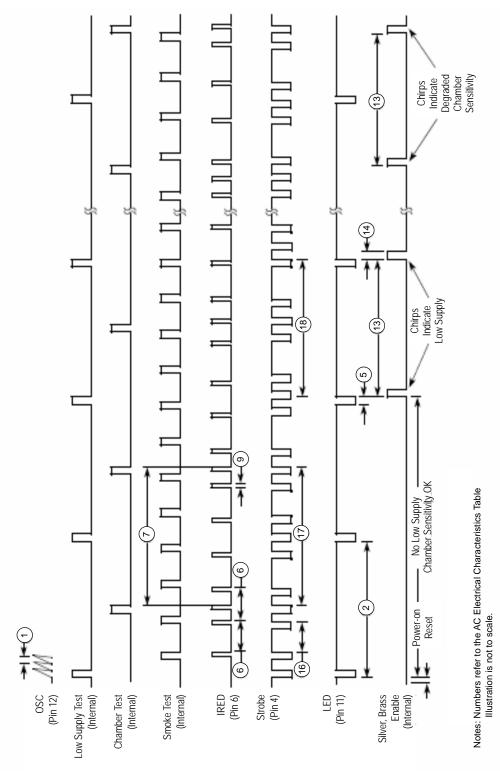


Figure 3. Typical Standby Timing Diagram MC146010 Device

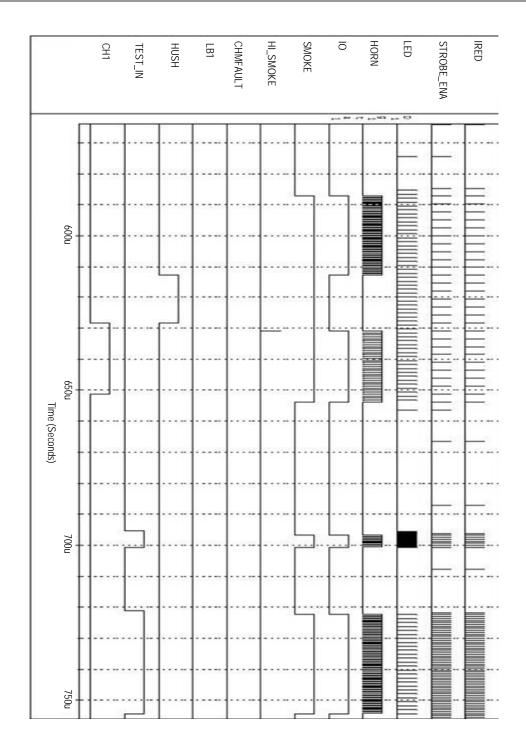


Figure 4. Typical Local Smoke Timing MC146010 Device

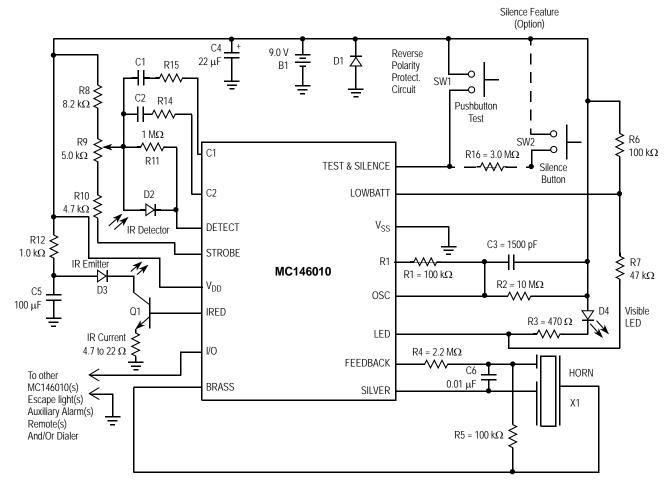


Figure 5. Typical Battery Powered Application

- # Values for R4, R5 and C6 may differ depending on type of horn used.
- \* C2 and R13 are used for coarse sensitivity adjustment. Typical values are shown.
- † R9 is for fine sensitivity adjustment (optional). If fixed resistors are used, R8 = 12k, R10 is 5.6k to 10k and R9 is eliminated.
- \*\* Components necessary to utilize IMF feature.

#### **PIN DESCRIPTIONS**

#### C1 (PIN 1)

A capacitor connected to this pin as shown in Figure 5 determines the gain of the on-chip photo amplifier during pushbutton test and chamber sensitivity test (high gain). The capacitor value is chosen such that the alarm tripped from background reflections in the chamber during pushbutton test.

AV = 1+(C1/10) where C1 is in pF. CAUTION: The value of the closed-loop gain should not exceed 10,000.

Resistor R15 should be installed in series with C1 for lower gains. R15 =[ $1/(12\sqrt{C1}]$ -680 where R15 is in ohms and C1 is in farads.

# C2 (PIN 2)

A capacitor connected to this pin as shown in Figure 5 determines the gain of the on-chip photo amplifier during pushbutton test and chamber sensitivity tests.

AV = 1+(C2/10) where C1 is in pF. This gain increases about 10% during IRED pulse, after two consecutive local smoke detections.

For proper compensation, resistor R14 must be installed in series with C2. R14 =[ $1/(12\sqrt{C2}]$ -680 where R14 is in ohms and C1 is in farads.

# **DETECT (PIN 3)**

This input to the high-gain pulse amplifier is tied to the cathode of an external photodiode. The photodiode should have low capacitance and low dark leakage current. The diode must be shunted by a load resistor and is operated at zero bias.

The Detect input must be ac/dc decoupled from all other signals,  $V_{DD}$  and  $V_{SS}$ . Lead length and/or foil traces to this pin must be minimized also. See Figure 3.

The device has a sampling speed-up mode after the first smoke sample is detected. The speed-up frequency is one smoke sample about every 2 seconds for the duration of a smoke condition. It will take no-smoke samples to return to a standby mode. Once out of a smoke condition, the IC will continue to sample for smoke about every 8 seconds.

#### STROBE (PIN 4)

This output provides the strobed, regulated voltage referenced to  $V_{DD}$ . The temperature coefficient of this voltage is  $\pm 0.2\%$ °C maximum from -10 to 60°C. The supply-voltage coefficient (line regulation) is  $\pm 0.2\%$ /V maximum from 6.0 to 12 V. Strobe is tied to external resistor string R8, R9 and R10.

## V<sub>DD</sub> (PIN 5)

This pin is connected to the positive supply potential and may range from +6.0 to +12 V with respect to  $V_{SS}$ .

CAUTION: In battery-powered applications, reversepolarity protection must be provided externally.

# IRED (PIN 6)

This output provides pulsed base current for external NPN transistor Q1 used as the infrared emitter driver. Q1 must have a  $\beta \geq$  100. At 10 mA, the temperature coefficient of the

output voltage is typically +0.5%/°C from -10 to 60°C. The supply-voltage coefficient (line regulation) is  $\pm 0.2\%$ /V maximum from 6.0 to 12 V. The IRED pulse width (activehigh) is determined by external components R1 and C3. With a 100 k $\Omega$ /1500 pF combination, the nominal width is 105  $\mu$ s.

To minimize noise impact, IRED is active near the end of strobe pulses for smoke tests, chamber sensitivity test, and pushbutton test. For the above mentioned width, IRED will be active for the last 105  $\mu$ s of strobe pulse.

#### I/O (PIN 7)

This pin can be used to connect up to 40 units together in a wired-OR configuration for common signaling.  $V_{SS}$  is used as the return. An on-chip current sink minimizes noise pickup during non-smoke conditions and eliminates the need for an external pull-down resistor to complete the wired-OR. Remote units at lower supply voltages do not draw excessive current from a sending unit at higher supply voltage.

I/O can also be used to activate escape lights, auxiliary alarms, remote alarms and/or auto-dialers.

As an input, this pin feeds a positive-edge-triggered flipflop whose output is sampled nominally every 1 second during standby (using typical component values). Once the first I/O remote smoke sample is detected, a second sample approximately 10 ms later will happen to confirm a remote smoke condition. If both samples are found to be high, the unit will start sounding an alarm.

I/O is disabled by the on-chip power-on reset to eliminate nuisance signaling during battery changes or system power-up.

If unused, I/O must be left unconnected.

# **BRASS (PIN 8)**

This half of the push-pull driver output is connected to the metal support electrode of the piezoelectric audio transducer and to the horn-starting resistor. A continuous modulated tone from the transducer is a smoke alarm indicating either local or remote smoke. A short beep or chirp is a trouble alarm indicating a low supply or degraded chamber sensitivity. A series of short beeps or chirps during a pushbutton test indicate a previous alarm for detected smoke (Alarm memory feature).

#### SILVER (PIN 9)

This half of the push-pull driver output is connected to the ceramic electrode of a piezoelectric transducer and to the horn-starting capacitor.

# **FEEDBACK (PIN 10)**

This input is connected to both the feedback electrode of a self-resonating piezoelectric transducer and the horn-starting resistor and capacitor through current limiting resistor R4. If unused, the pin must be tied to  $V_{SS}$  or  $V_{DD}$ .

# LED (PIN11)

This active-low open drain output directly drives an external visible LED at the pulse rate indicated below. The pulse width is equal to the OSC period.

MC146010

The load for the low-supply test is non-coincident with the smoke tests, chamber sensitivity test, pushbutton test, or any alarm signals.

The LED also provides a visual indication of the detector status as follows, assuming the component values shown in Figure 4:

Standby (includes low-supply and chamber sensitivity tests) — Pulses every 32.4 seconds.

Local Smoke — Pulses every 2.0 seconds (typical)

Mute — Pulses every 2.0 seconds (typical)

Remote Smoke — No Pulses

Pushbutton test — Pulses every 2.0 seconds

#### **OSC (PIN 12)**

This pin is used in conjunction with external resistor R2 (7.5  $\text{M}\Omega)$  to  $\text{V}_{\text{DD}}$  and external capacitor C3 (1500 pF) to  $\text{V}_{\text{DD}}$  to form an oscillator with a nominal period of 7.9 msec (typical).

## R1 (PIN 13)

This pin is use din conjunction with resistor R1(100 k $\Omega$ ) to pin 12 and C3 (1500 pF, see pin 12 description) to determine the IRED pulse width. With this RC combination, the nominal pulse width is 105  $\mu$ s.

## **V<sub>SS</sub> (PIN 14)**

This pin is the negative supply potential and the return for the I/O pin. Pin 14 is usually tied to Ground.

#### **LOW-SUPPLY TRIP (PIN 15)**

This pin is connected to an external voltage which determines the low-supply alarm threshold. The trip voltage is obtained through a resistor divider connected between the  $V_{DD}$  and LED pins. The low-supply alarm threshold voltage (in volts) = (5R7/R6)+5 where R6 and R7 are in the same units.

## **TEST/MUTE (PIN 16)**

This input has an on-chip pull-down device and is used to manually invoke a test mode, a mute mode, or a calibration mode.

The *Pushbutton Test* mode is initiated by a high level at Pin 16 (usually a depression of a S.P.S.T. normally-open pushbutton switch to  $V_{DD}$ ). After one oscillator cycle, the IRED pulses approximately every 1.0 second, regardless of the presence of smoke. Additionally, the amplifier gain is increased by automatic selection of C1. Therefore the background reflections in the smoke chamber may be interpreted as smoke, generating a simulated smoke condition. After the second IRED pulse, a successful test activates the horn-driver and I/O circuits. The active I/O allows remote signaling for a system testing. When the Pushbutton Test switch is released, the Test input returns to  $V_{SS}$  due to the on-chip pull-down device. After one oscillator

cycle, the amplifier gain returns to normal, thereby removing the simulated smoke condition. After two additional IRED pulses, less than three seconds, the IC exits the alarm mode and returns to standby timing.

The Pushbutton Test will also activate the Alarm Memory feature. If there was a previous alarm detected by the unit, the horn will chirp every ¼ second as long as the Test Button is pressed. Upon releasing of the Test Button, Alarm memory will be reset. Subsequent pressing of the Test Button will result in a Pushbutton Test for simulated smoke.

Pressing the Test Button while in the MUTE mode will result in resetting of MUTE (and additionally a normal Pushbutton Test).

The MUTE mode (IMF) is initiated by a mid level voltage (around  $\frac{1}{2}$  V<sub>DD</sub>) at pin 16. A parallel Mute Button to an existing Test Button needs to be installed at the test pin. A smoke condition must be present for the MUTE mode to be activated. If a no smoke condition gets detected while in the MUTE mode, the IMF 8 minute window gets reset. The unit will return to Standby mode.

Once in the MUTE mode, the audible smoke alarm (horn) is temporarily disabled for approximately 8 minutes while smoke condition is being detected. A visual smoke alarm will remain (LED flashing) during MUTE mode. A high smoke voltage reference will also be activated at this time. Simultaneous smoke and high smoke sampling will allow the unit to enable the horn driver in case a high smoke condition occurs during MUTE where the high smoke threshold is crossed.

The MUTE mode can be overridden by the following conditions: 1) a no smoke condition is detected, 2) high smoke level detected, 3) remote smoke detected through I/O, 4) reset through test Button, 5) timeout of 8 minute window. To help prevent a jammed Mute Button condition, the divider string on the Mute Button should include a resistor to  $V_{DD}$ , R15 (around 10 M $\Omega$ ) and a resistor R16 (4.7 M $\Omega$ ) and capacitor, C7 (0.047 mF) in series to  $V_{SS}$ .

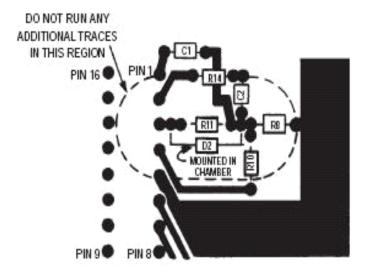
#### **CALIBRATION**

To facilitate checking the sensitivity and calibrating smoke detectors, the MC146010 can be placed in Calibration mode. In this mode, certain device pins are controlled/reconfigured as shown in Table 4. To place the part in Calibration mode, Pin 16 (Test/ Mute) must be pulled below  $V_{SS}$  pin with 100  $\mu\text{A}$  continuously drawn out of the pin for at least one cycle of the OSC pin. To exit this mode, the Test/ Mute pin is floated for at least one OSC cycle.

In the Calibration mode, the IRED pulse rate is increased. An IRED pulse occurs every clock cycle. Also, Strobe is always Active Low. It is recommended to short R12 (Figure 5) in this mode. This will allow for a similar recovery of the emitter circuitry as in normal operation. Pin 1, pin 2, and pin 12 should be buffered with a unity gain amplifier to measure their outputs.

Table 4. MC146010 Test Mode Logic Table

| Pin                     | Function                        | Туре   | Logic | Description   |
|-------------------------|---------------------------------|--------|-------|---|
| Pin 16, TEST            | Test Mode 1 Trigger             | Input  | None  | Set a –Ve voltage to the pin and source 100 $\mu A$ from the pin to start Test Mode 1.          |
| Pin 12, OSC CAP         | Clock Input                     | Input  | 0     | Internal clock low  |
|                         |                                 |        | 1     | Internal clock high   |
| Pin 5, V <sub>DD</sub>  | Chip Power                      |        |       |   |
| Pin 14, V <sub>SS</sub> | Chip Ground                     |        |       |   |
| Pin 11, LED             | Built-in-Test for HUSH<br>Timer | Output |       | Output pulse active low for 8 Clocks every 128 Clocks.  |
| Pin 4, STROBE           | Analog Ground                   | Output |       | Output low when pin 12 is low.  |
| Pin 6, IRED             | IRED                            | Output | 0     | Output low when pin 12 is low.  |
|                         |                                 |        | 1     | Output high (3.0 V) when pin 12 is high.  |
| Pin 3, DETECT           | Smoke Sensing Input             | Input  |       | NO SMK: V <sub>DD</sub> -2.5 V – (1/Hi Gain)  |
|                         |                                 |        |       | SMK: V <sub>DD</sub> -2.5 V –(1/Low Gain)   |
|                         |                                 |        |       | HI SMK: V <sub>DD</sub> -2.5 V – (2/Low Gain)   |
| Pin 8, BRASS            | Smoke Latch Indicator           | Output | 0     | Output low when smoke latch not set.  |
|                         |                                 |        | 1     | Output high when smoke latch set.   |
| Pin 9, SILVER           | Photo-Comparator<br>Indicator   | Output | 0     | Output low when photo comparator not set.   |
|                         |                                 |        | 1     | Output high when photo comparator set.  |
| Pin 7, I/O              | Photo-Amp Routing<br>Enable     | Input  | 0     | Disable the function of Pin 1, 2, 10 and 15 in Test Mode 1.                                     |
|                         |                                 |        | 1     | Enable photoamplifier output routed to the pins and enable pins 1, 2, 10 and 15 in test Mode 1. |
| Pin 15, LOW_BATT        | Low Battery Trip Point          | Input  |       | Control photo amp. Gain and output routing  |
| Pin 10, FEEDBACK        | Feedback                        | Input  |       | Control hysteresis  |



NOTES: Illustration is bottom view of layout using a DIP. Top view for SOIC layout is mirror image.

Optional potentiometer R9 is not included.

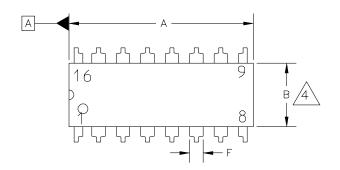
Drawing is not to scale.

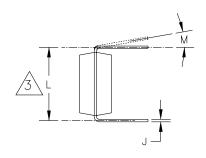
Leads on D2, R11, R8, and R10 and their associated traces must be kept as short as possible.

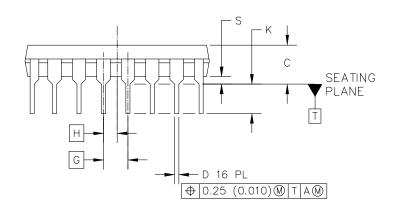
This practice minimizes noise pick up.

Pin 3 must be decoupled from all other traces.

Figure 6. Recommended PCB layout







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|--|--|--------------|------------------|-------------|
| TITLE:   |  | DOCUMENT NO  | 1: 98ASB42431B   | REV: T      |
| 16 LD PDIP   |  | CASE NUMBER  | : 648-08         | 19 MAY 2005 |
| 10 60 1011   |  | STANDARD: NO | IN-JEDEC         |             |

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98ASB42431B ISSUE T PLASTIC DIP

MC146010

## NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: INCH.
- A DIMENSION TO CENTER OF LEADS WHEN FORMED PARALLEL.
- A. DIMENSIONS DOES NOT INCLUDE MOLD FLASH.
- 5. ROUNDED CORNERS OPTIONAL.
- 6. 648-01 THRU -08 OBSOLETE, NEW STANDARD 648-09.

|       | MILLIN                                    | 1ETERS | ı     | NCHES     |          | MILL    | IMETERS     |         | NCHES       |
|-------|---|--------|-------|-----------|----------|---------|-------------|---------|-------------|
| DIM   | MIN                                       | MAX    | MIN   | MAX       | DIM      | MIN     | MAX         | MIN     | MAX         |
| А     | 18.80                                     | 19.55  | 0.740 | 0.770     |          |         |             |         |             |
| В     | 6.35                                      | 6.85   | 0.250 | 0.270     |          |         |             |         |             |
| С     | 3.69                                      | 4.44   | 0.145 | 0.175     |          |         |             |         |             |
| D     | 0.39                                      | 0.53   | 0.015 | 0.021     |          |         |             |         |             |
| F     | 1.02                                      | 1.77   | 0.040 | 0.070     |          |         |             |         |             |
| G     | 2.54                                      | BSC    | 0.    | 100 BSC   |          |         |             |         |             |
| Н     | 1.27                                      | BSC    | 0.0   | 050 BSC   |          |         |             |         |             |
| J     | 0.21                                      | 0.38   | 0.008 | 0.015     |          |         |             |         |             |
| K     | 2.80                                      | 3.30   | 0.110 | 0.130     |          |         |             |         |             |
| L     | 7.50                                      | 7.74   | 0.295 | 0.305     |          |         |             |         |             |
| М     | 0.  | 10.    | 0.    | 10°       |          |         |             |         |             |
| S     | 0.51                                      | 1.01   | 0.020 | 0.040     |          |         |             |         |             |
| © FF  | © FREESCALE SEMICONDUCTOR, INC. MECHANICA |        |       | MECHANICA | L OUT    | LINE    | PRINT VER   | SION NO | OT TO SCALE |
| TITLE | TITLE:                                    |        |       |           | DOCU     | MENT NO | : 98ASB4243 | 1B      | REV: T      |
|       | 16 LD PDIP                                |        |       |           | CASE     | NUMBER  | : 648-08    |         | 19 MAY 2005 |
|       |   |        |       | STAN      | DARD: NO | N-JEDEC |             |         |             |

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98ASB42431B ISSUE T PLASTIC DIP

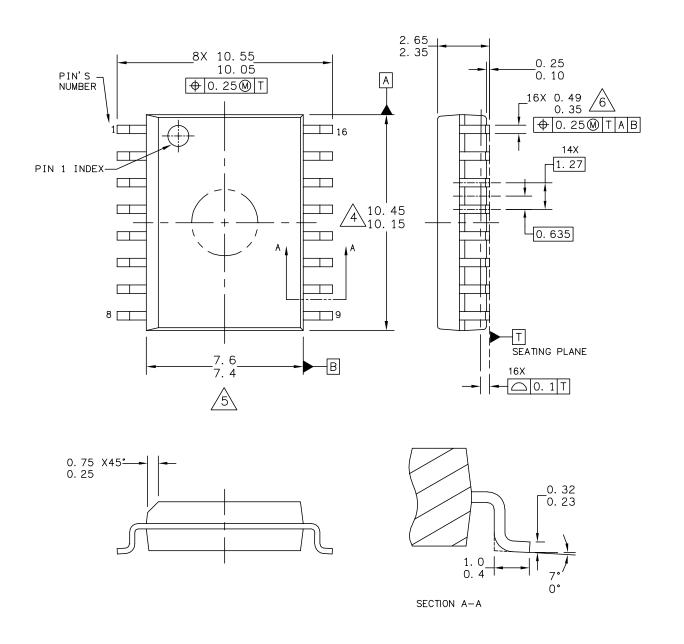
STYLE 1: STYLE 2: PIN 1. CATHODE PIN 1. COMMON DRAIN 2. CATHODE 2. COMMON DRAIN 3. COMMON DRAIN 3. CATHODE 4. CATHODE 4. COMMON DRAIN 5. CATHODE 5. COMMON DRAIN 6. CATHODE 6. COMMON DRAIN 7. CATHODE 7. COMMON DRAIN 8. CATHODE 8. COMMON DRAIN 9. ANODE 9. GATE 10. ANODE 10. SOURCE 11. ANODE 11. GATE 12. ANODE 12. SOURCE 13. ANODE 13. GATE 14. ANODE 14. SOURCE 15. ANODE 15. GATE 16. ANODE 16. SOURCE

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| TITLE:   |              | DOCUMENT NO                  | ): 98ASB42431B   | REV: T      |
| 16 LD PDIP   |              | CASE NUMBER: 648-08 19 MAY 2 |                  |             |
|  | STANDARD: NO | N-JEDEC                      |                  |             |

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|--|-----------|--------------|------------------|-------------|
| TITLE:   | 07 DITOL  |              | ): 98ASB42567B   | REV: F      |
| 16LD SOIC W/B, 1.<br>CASE-OUTLI                      |           | CASE NUMBER  | R: 751G-04       | 02 JUN 2005 |
| CN3L-001L1   | INL       | STANDARD: JE | IDEC MS-013AA    |             |

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98ASB42567B ISSUE F SOIC PACKAGE

#### NOTES:

- 1. DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. DATUMS A AND B TO BE DETERMINED AT THE PLANE WHERE THE BOTTOM OF THE LEADS EXIT THE PLASTIC BODY.
- THIS DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURRS. MOLD FLASH, PROTRUSION OR GATE BURRS SHALL NOT EXCEED 0.15 MM PER SIDE. THIS DIMENSION IS DETERMINED AT THE PLANE WHERE THE BOTTOM OF THE LEADS EXIT THE PLASTIC BODY.
- THIS DIMENSION DOES NOT INCLUDE INTER-LEAD FLASH OR PROTRUSIONS. INTER-LEAD FLASH AND PROTRUSIONS SHALL NOT EXCEED 0.25 MM PER SIDE. THIS DIMENSION IS DETERMINED AT THE PLANE WHERE THE BOTTOM OF THE LEADS EXIT THE PLASTIC BODY.
- THIS DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED 0.62 mm.

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|--|------------------|--------------|------------------|-------------|
| TITLE:   | D # # 0.1.       | DOCUMENT NO  | : 98ASB42567B    | REV: F      |
| 16LD SOIC W/B, 1.27 F                                | PIICH, [         | CASE NUMBER  | 2: 751G-04       | 02 JUN 2005 |
| CASE OUTEINE   |                  | STANDARD: JE | DEC MS-013AA     |             |

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98ASB42567B ISSUE F SOIC PACKAGE

MC146010

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